# 3A Adjustable Output Voltage LDO Regulator

## **General Description**

The RT9033 is a low dropout linear regulator designed for high output current applications with critical performance. The IC responds very fast to step changes in load, which is suitable for low voltage microprocessor applications.

The RT9033 uses an internal P-MOSFET as the pass device, which does not cause extra GND current in heavy load and dropout condition. The shutdown mode of low operation current makes the IC suitable for power-saving systems.

The RT9033 also works well with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications and consumes less than  $1\mu A$  in shutdown mode. The other features include ultra low dropout voltage, high output accuracy, current limiting protection and over temperature protection. The RT9033 is available in the TO-263-5 package.

## **Ordering Information**

Package Type
M5: TO-263-5

Lead Plating System
G: Green (Halogen Free and Pb Free)

#### Note:

Richtek products are:

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

### **Features**

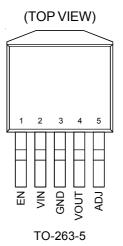
High Current Capability: 3A
Low Dropout: 350mV at 3A
Low Ground Current: 250μA
Adjustable Output Voltage

- Extremely Low Output Capacitor Requirement
- Internal Over Current Protection
- Internal Over Temperature Protection
- RoHS Compliant and Halogen Free

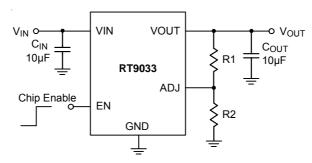
## **Applications**

- Battery-Powered Equipment
- High Efficiency "Green" Computer Systems
- Automotive Electronics
- High Efficiency Linear Lower Supplies
- High Efficiency Lost-Regulator for Switching Supply

# **Pin Configurations**



# **Typical Application Circuit**



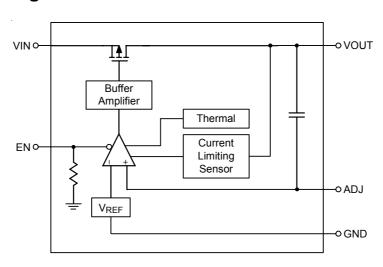
Note: Vout = VREF x  $(1+\frac{R1}{R2})$ 



# **Function Pin Description**

Pin No.	Pin Name	Pin Function					
1	EN	Enable Input Logic, Active High. When the EN goes to a logic low or floating, the device is in shutdown mode.					
2	VIN	Power Supply Input Pin.					
3	GND	Ground Pin.					
4	VOUT	Regulator Output Pin.					
5	ADJ	Adjustable Output Pin					

# **Function Block Diagram**





# Absolute Maximum Ratings (Note 1)

Supply Input Voltage, VIN	6V
• EN Input Voltage, EN	6V
• All Other Pins	0.3V to 6V
<ul> <li>Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C</li> </ul>	
TO-263-5	3.448W
Package Thermal Resistance (Note 2)	
TO-263-5, $\theta_{JA}$	29°C/W
TO-263-5, $\theta_{JC}$	7°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
• Junction Temperature	
Storage Temperature Range	65°C to 150°C
ESD Susceptibility (Note 3)	
HBM	2kV
MM	200V
Recommended Operating Conditions (Note 4)	
Supply Input Voltage, V <sub>IN</sub>	2.5V to 5.5V

### **Electrical Characteristics**

 $(V_{IN} = 5V,\, V_{EN} = V_{IN},\, C_{IN} = C_{OUT} = 10 \mu F \,\, (Ceramic),\, T_A = 25^{\circ}C \,\, unless \,\, otherwise \,\, specified)$ 

Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Input Power							
Quiescent Current		IQ			250		μΑ
Shutdown Current		I <sub>SHDN</sub>	V <sub>EN</sub> = GND		100		nA
Reference Vo	ltage				,		
Reference Voltage		$V_{REF}$	$V_{ADJ} = V_{OUT}$		1.24		V
Reference Voltage Tolerance			I <sub>OUT</sub> = 10mA	-1		1	%
Regulation							
Line Regulation		$\Delta V_{LINE}$	I <sub>OUT</sub> = 10mA, (V <sub>OUT</sub> +1) <v<sub>IN&lt;5V</v<sub>		0.06	0.5	%
Load Regulation		$\Delta V_{LOAD}$	10mA < I <sub>OUT</sub> < 3A, V <sub>IN</sub> = 5V		0.2	1	%
Output							
Output Current Limit		I <sub>LIM</sub>	$V_{IN} = V_{OUT} + 1$		4.5	5.5	Α
Dropout Voltage		$V_{DROP}$	I <sub>OUT</sub> = 3A		350	600	mV
Enable							
EN Threshold	Logic-Low Voltage	V <sub>IL</sub>				0.4	V
	Logic-High Voltage	V <sub>IH</sub>		1.2			, v
Enable Pin Current		I <sub>EN</sub>	$V_{IN} = V_{EN}$			20	μΑ

To be continued



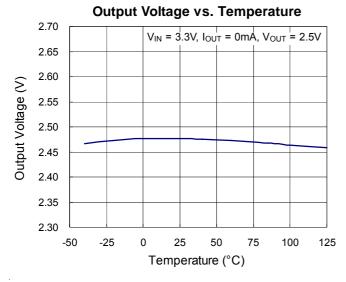
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Thermal Protection						
Thermal Shutdown Temperature	T <sub>SD</sub>			165		°C
Thermal Shutdown Hysteresis	$\Delta T_{SD}$			30		

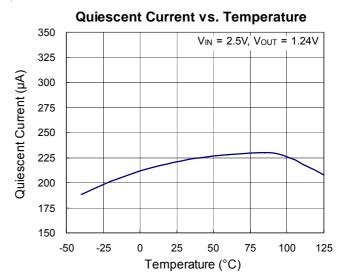
- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2.  $\theta_{JA}$  is measured in the natural convection at  $T_A$  = 25°C on a high effective four layers thermal conductivity test board of JEDEC 51-7 thermal measurement standard. The case point of  $\theta_{JC}$  is on the exposed pad for the package. The copper area as heat sink is 225mm<sup>2</sup>.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.

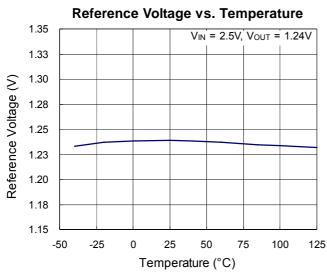


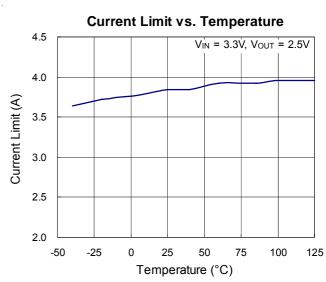
# **Typical Operating Characteristics**

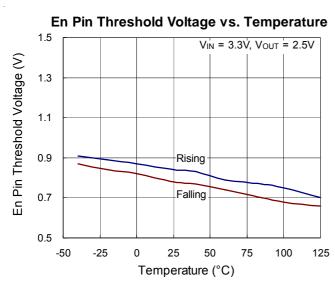
 $C_{\text{IN}} = C_{\text{OUT}} = 10 \text{uF/X7R}, \ \text{R1} = \text{R2} = 130 \text{k}\Omega, \text{unless otherwise specified.}$ 

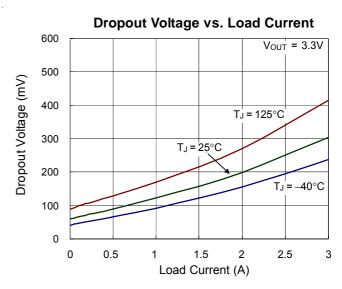








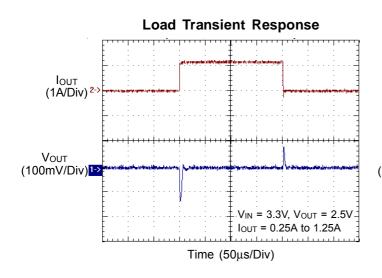


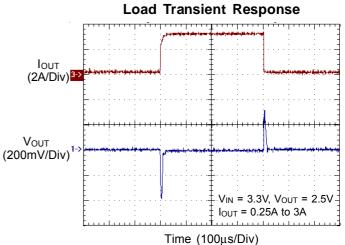


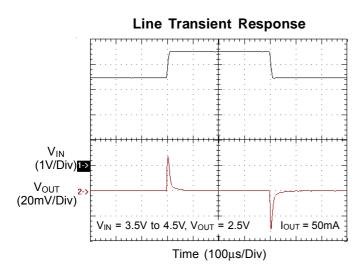
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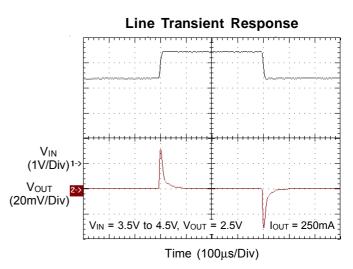
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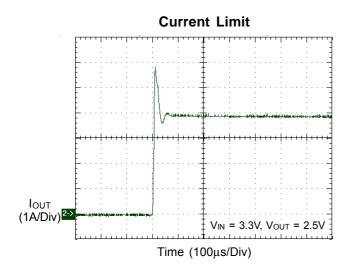


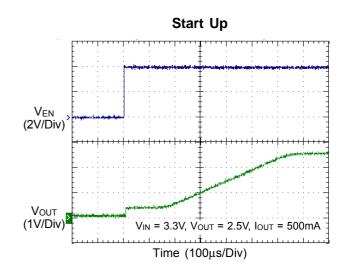














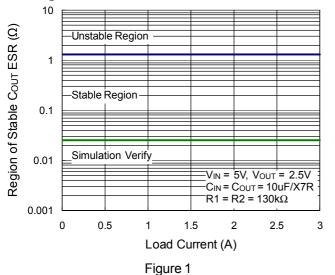
## **Applications Information**

#### Input and Output Capacitor Selection

Like any low-dropout regulator, the external capacitors used with the RT9033 must be carefully selected for regulator stability and performance. Using a capacitor whose value is >  $10\mu F$  on the RT9033 input and the amount of capacitance can be increased without limit. The input capacitor must be located at a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better line-transient response.

The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The RT9033 is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least  $1\mu F$  with ESR is >  $25 m\Omega$  on the RT9033 output ensures stability. The RT9033 still works well with output capacitor of other types due to the wide stable ESR range. Figure 1. shows the curves of allowable ESR range as a function of load current for various output capacitor values. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located at not more than 0.5 inch from the VOUT pin of the RT9033 and returned to a clean analog ground.





#### **Output Voltage Setting**

The RT9033 output voltage can provide 1.24V to 4.9V (dropout voltage maximum 0.6V) operating rating. To use two resistors to adjust the customer's ideal output voltage. Resistors can be large to up to  $1M\Omega$ , because of the very high impedance and low bias current of the sense comparator: The resistor values are calculated by :

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R1}{R2}\right)$$

### **Chip Enable Operation**

The RT9033 goes into sleep mode when the Enable pin is in a logic low condition. During this condition, the pass transistor, error amplifier, and band gap are turned off, reducing the supply current to  $0.1\mu A$ . The Enable pin can be directly tied to VIN to keep the part on.

#### **Current Limit**

The RT9033 contains an independent current limiter, which monitors and controls the pass transistor's gate voltage, limiting the output current to 4.5A (typ.).

### **PSRR**

The power supply rejection ratio (PSRR) is defined as the gain from the input to output divided by the gain from the supply to the output. The PSRR is found to be

$$PSRR = 20 \times Log \left( \frac{\Delta Gain Error}{\Delta Supply} \right) (dB)$$

Note that when heavy load measuring,  $\Delta$  supply will cause  $\Delta$  temperature. And  $\Delta$  temperature will cause  $\Delta$  output voltage. So the heavy load PSRR measuring is including temperature effect.

#### **Thermal Considerations**

For continuous operation, do not exceed absolute maximum operation junction temperature. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula:

 $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$ 

Where  $T_{J(MAX)}$  is the maximum operation junction temperature,  $T_A$  is the ambient temperature and the  $\theta_{JA}$  is the junction to ambient thermal resistance.

For recommended operating conditions specification of RT9033, the maximum operating junction temperature is  $125^{\circ}C$ . The junction to ambient thermal resistance  $\theta_{JA}$  is layout dependent. As shown in Figure 2, RT9033 TO-263-5 with 15mm x 15mm PCB copper area on the standard JEDEC 51-7 four layers thermal test board thermal resistance  $\theta_{JA}$  is about 29°C/W. The maximum power dissipation at  $T_A$  = 25°C can be calculated by following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (29^{\circ}C/W) = 3.448W$  for TO-263-5 packages

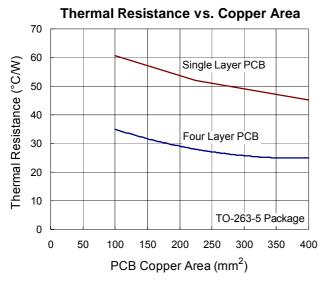


Figure 2. Thermal Resistance  $\theta_{JA}$  vs. Copper Area of TO-263-5 Packages

The maximum power dissipation depends on operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance  $\theta_{JA}$ . For RT9033 packages, the Figure 3 of de-rating curves allows the designer to see the effect of rising ambient temperature on the maximum power allowed.

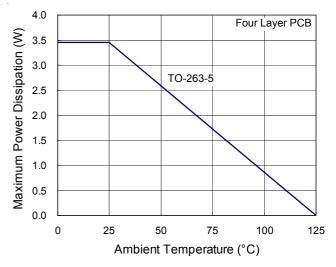
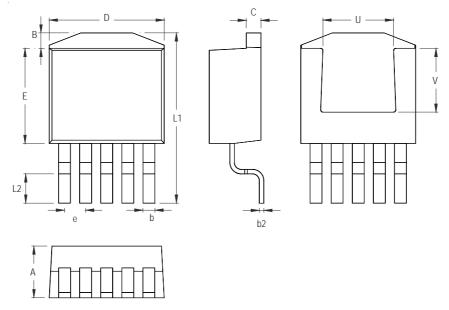


Figure 3. Derating Curves for RT9033 Packages



### **Outline Dimension**



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	4.064	4.826	0.160	0.190	
В	1.143	1.676	0.045	0.066	
b	0.660	0.914	0.026	0.036	
b2	0.305	0.584	0.012	0.023	
С	1.143	1.397	0.045	0.055	
D	9.652	10.668	0.380	0.420	
Е	8.128	9.652	0.320	0.380	
е	1.524	1.829	0.060	0.072	
L1	14.605	15.875	0.575	0.625	
L2	2.286	2.794	0.090	0.110	
U	6.223 Ref.		0.245 Ref.		
V	7.620 Ref.		0.300 Ref.		

5-Lead TO-263 Surface Mount Package

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